

Fig.1

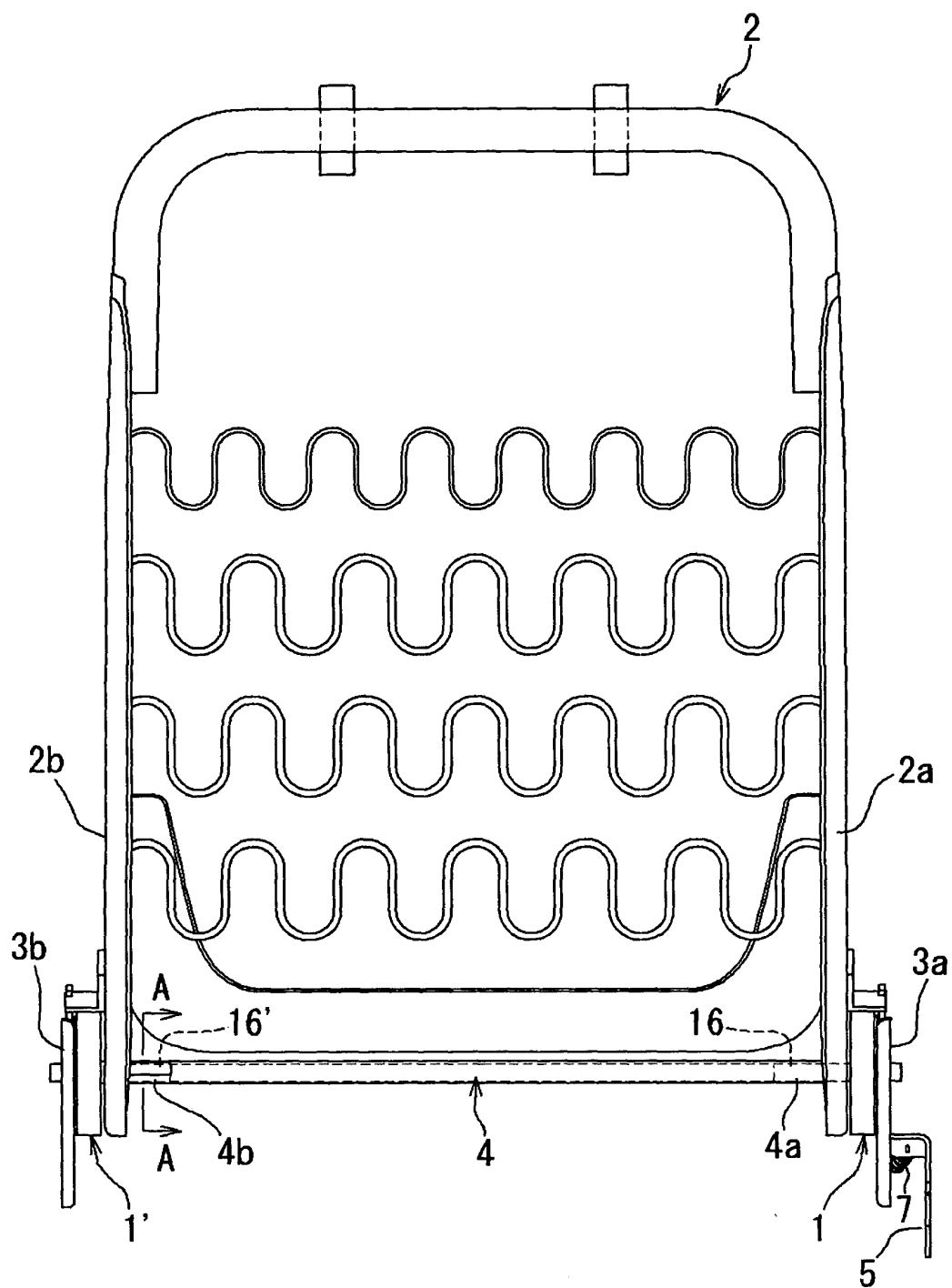


Fig.2

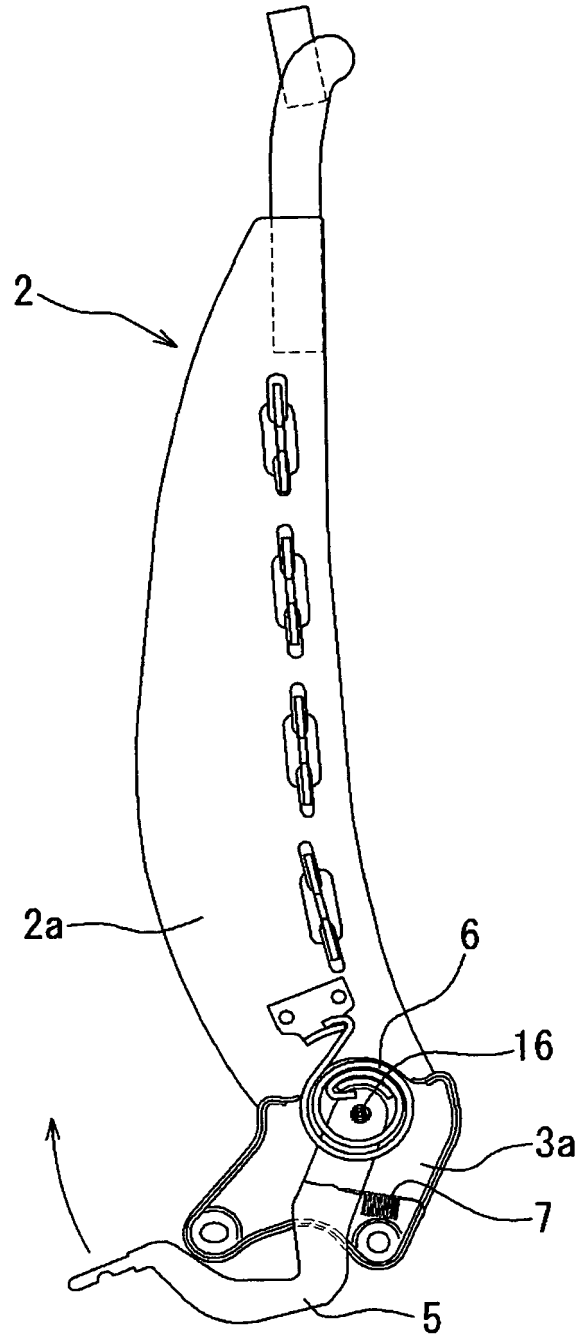


Fig. 3

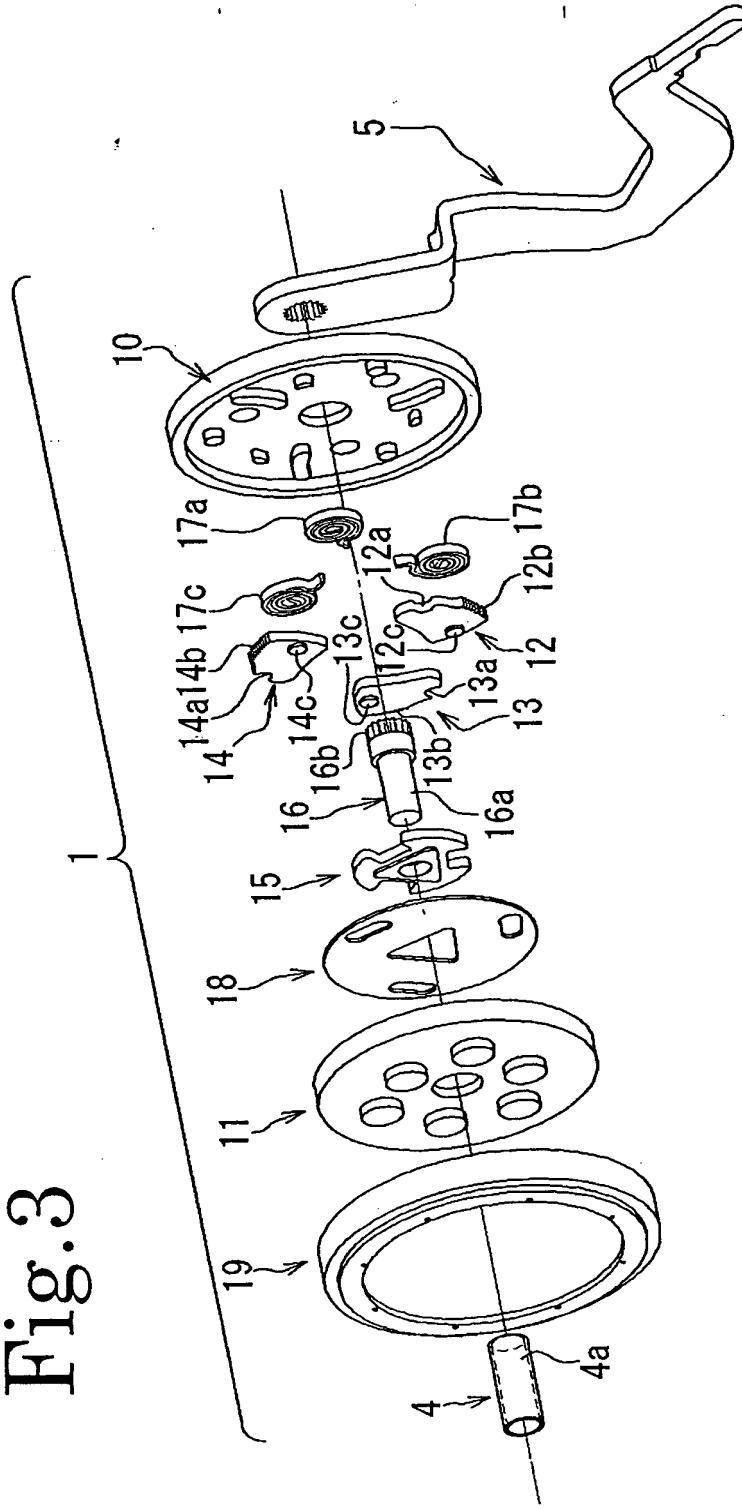


Fig.4

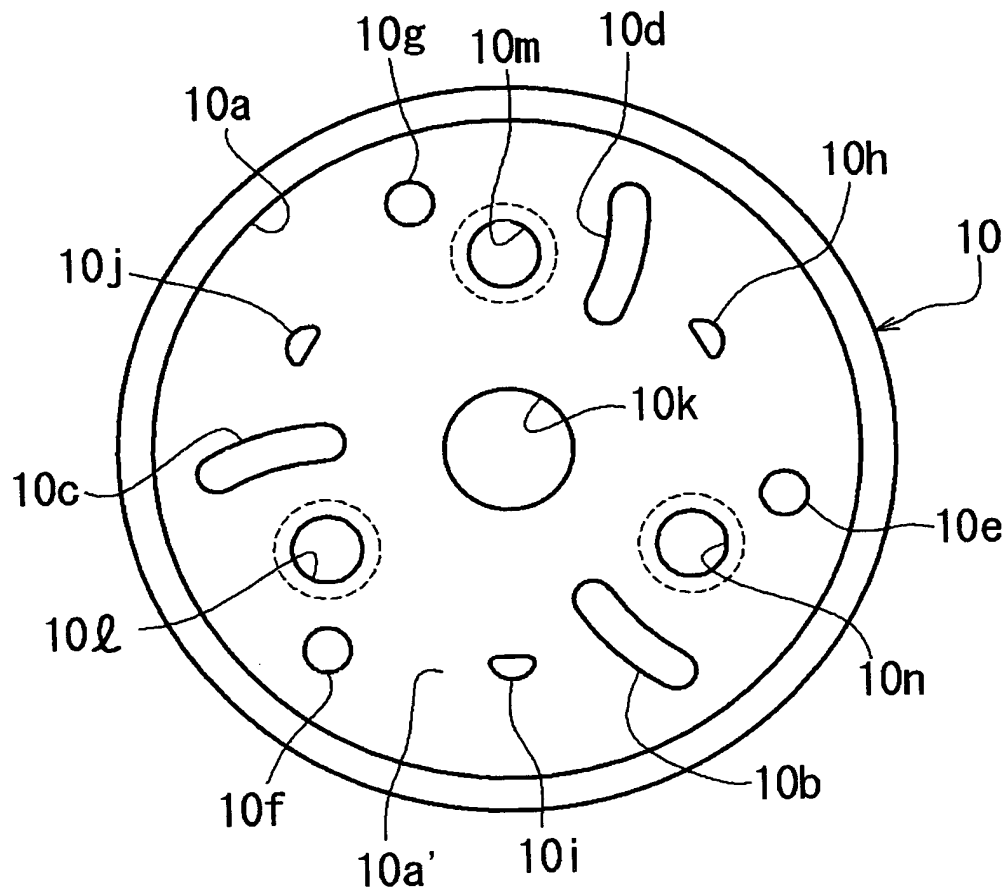


Fig.5

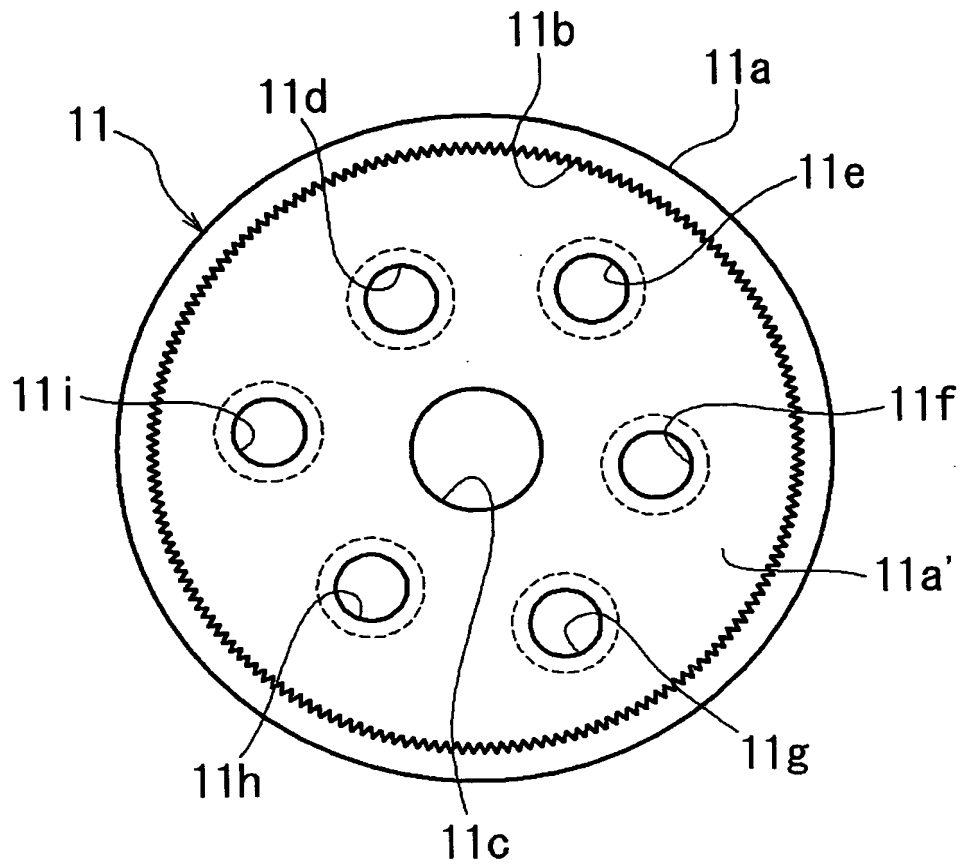


Fig.6

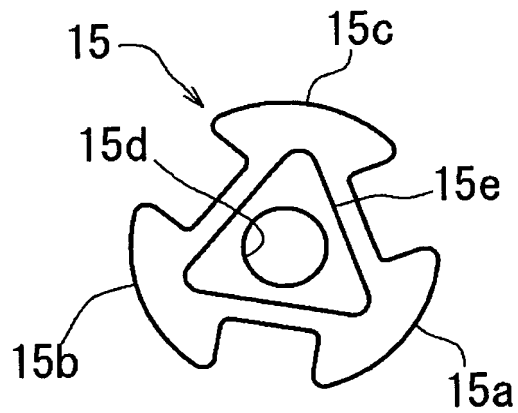


Fig.7

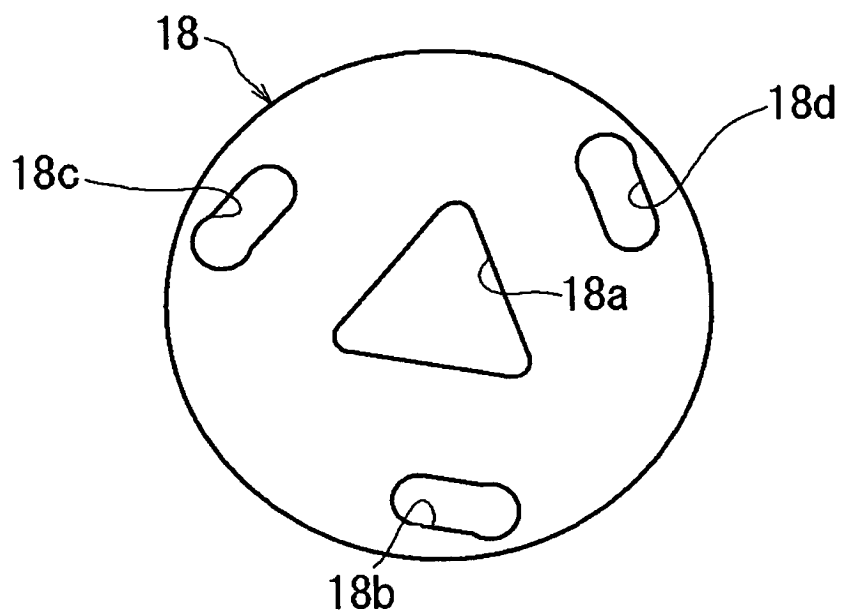


Fig 8

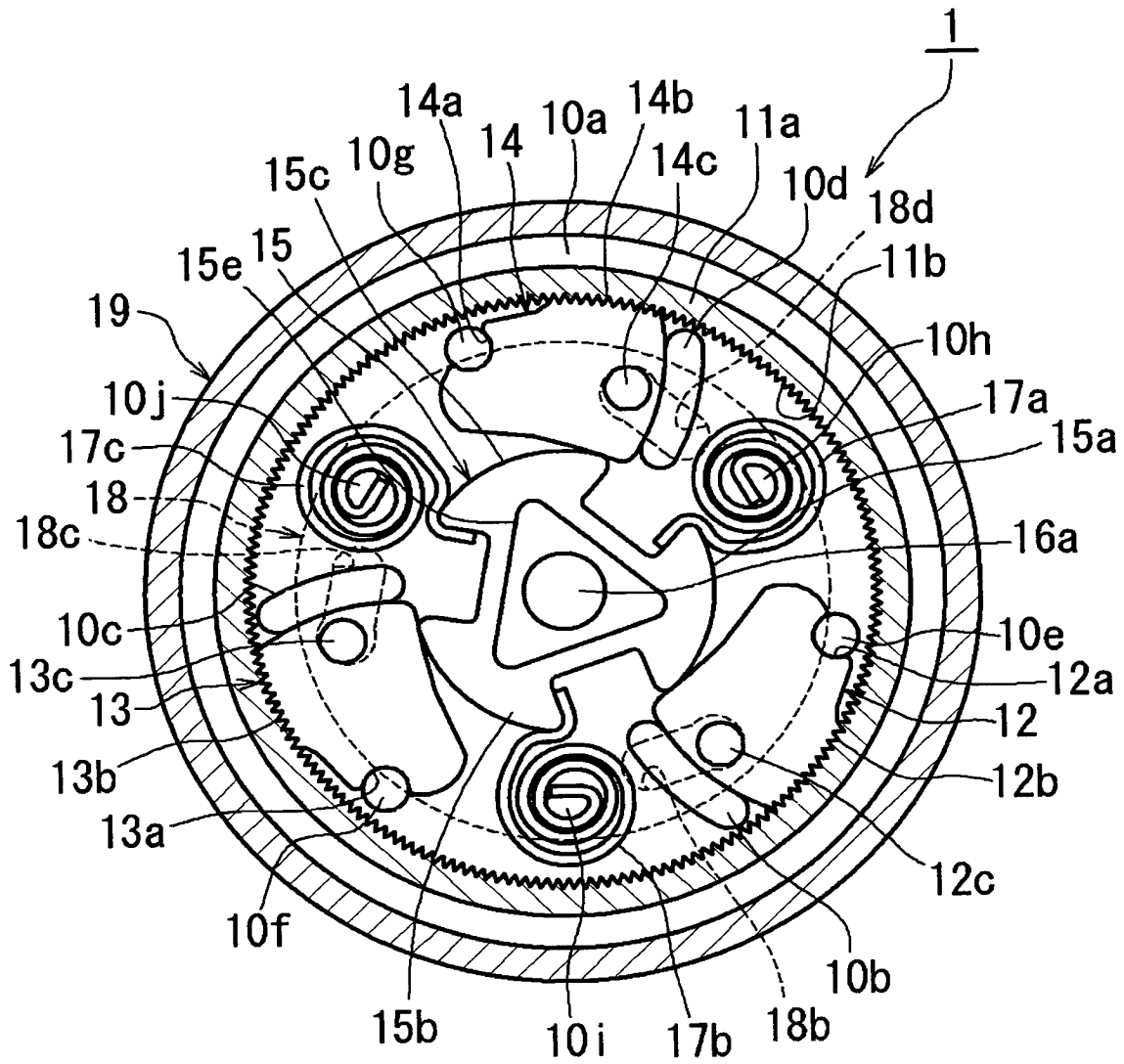
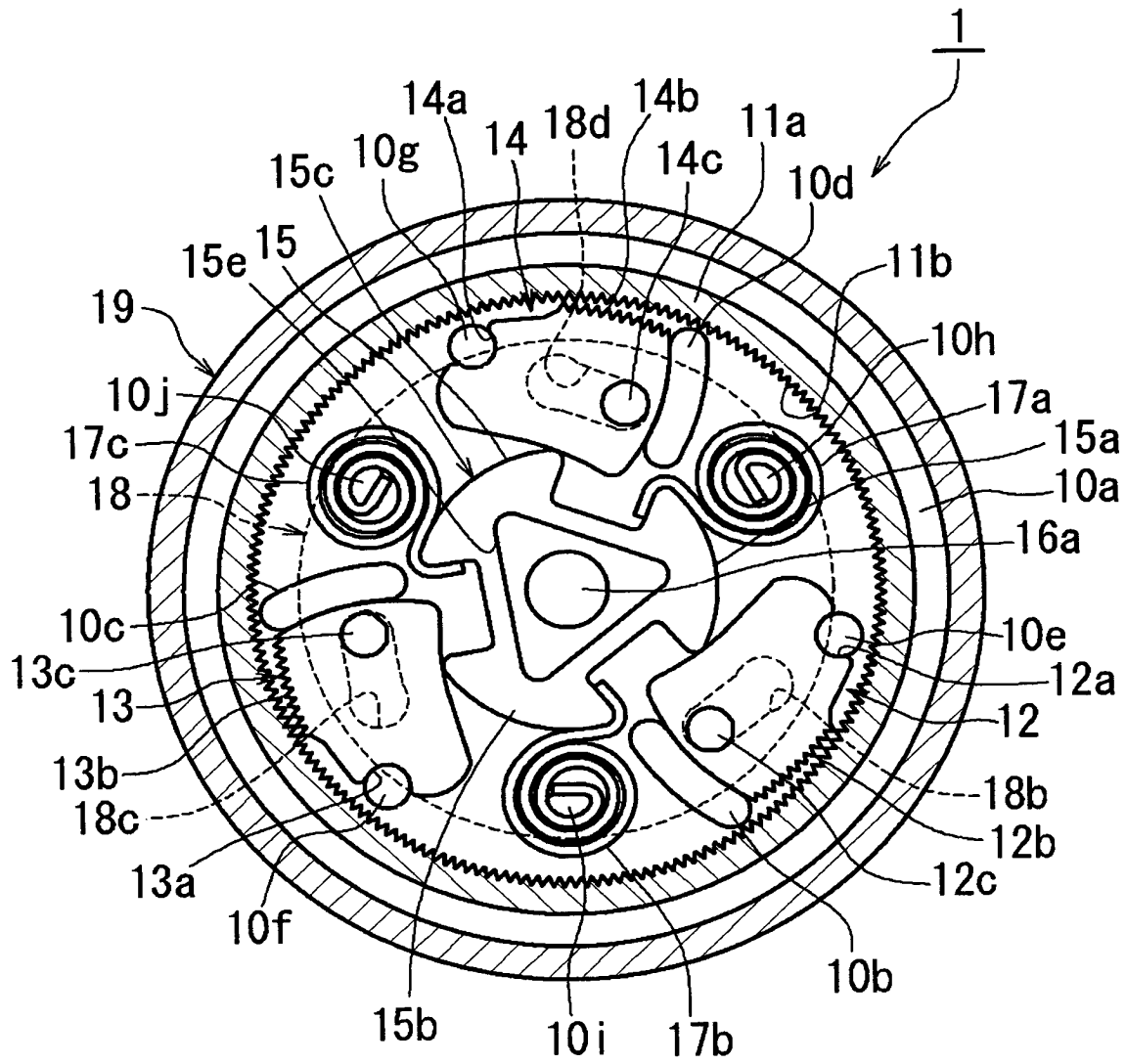


Fig.9



This diagram shows an exploded perspective view of a multi-layered circular device assembly, indicated by a bracketed label 1' on the left. The assembly consists of several main components arranged vertically along a central axis:

- Bottom Layer (10):** A circular base plate with various internal features labeled 10a, 10b, 10c, 10d, 10e, 10f, 10g, 10h, 10i, 10j, 10k, 10l, 10m, and 10n.
- Coil Assembly (12):** A central component featuring a coil (12a) and a base (12b). It includes a central shaft (12c) and a top cap (12d).
- Intermediate Layer (13):** A circular plate with a central opening (13a) and a surrounding ring (13b).
- Top Layer (11):** A circular plate with a central opening (11a) and a surrounding ring (11b). It features a central shaft (11c) and a top cap (11d).
- Outer Ring (19):** A circular ring with a central opening (19a) and a surrounding ring (19b).

The diagram illustrates the spatial relationship and assembly sequence of these components, with various sub-components and features labeled with alphanumeric codes.

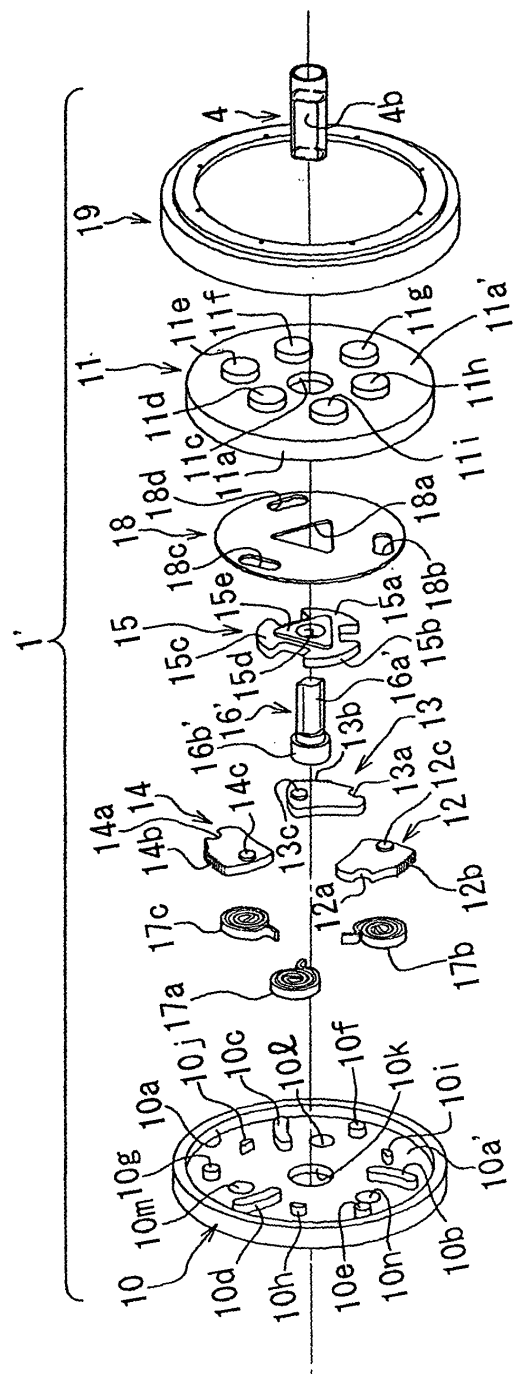


Fig.11

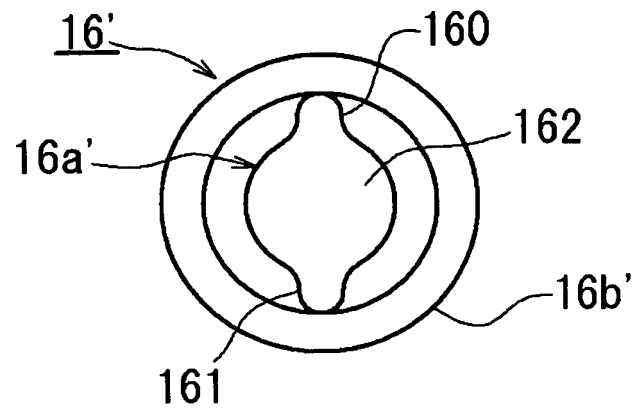


Fig.12

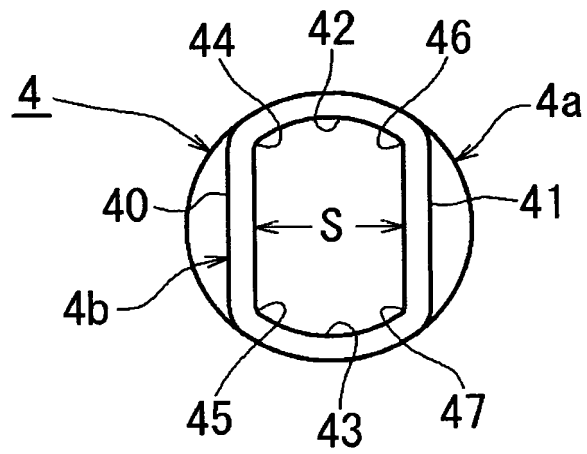


Fig.13

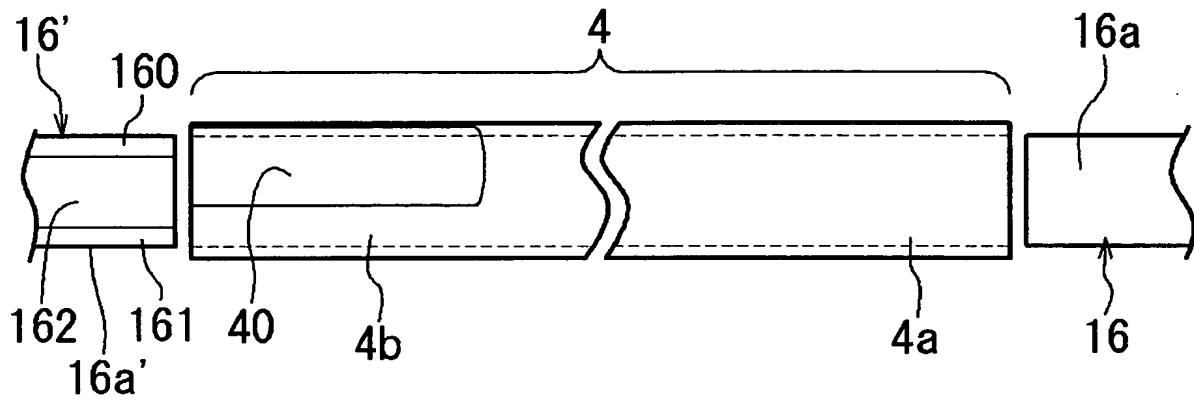


Fig.14

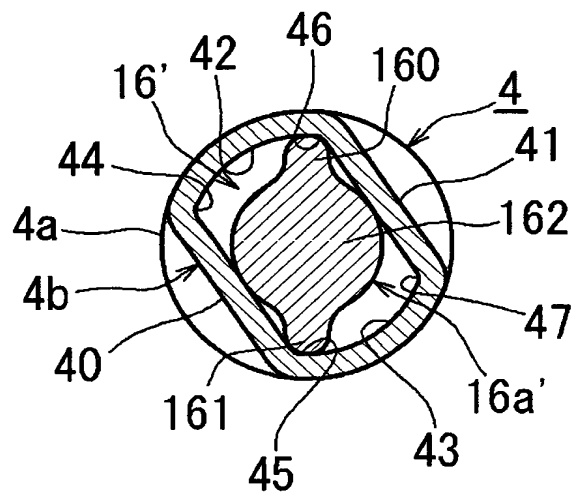


Fig.15

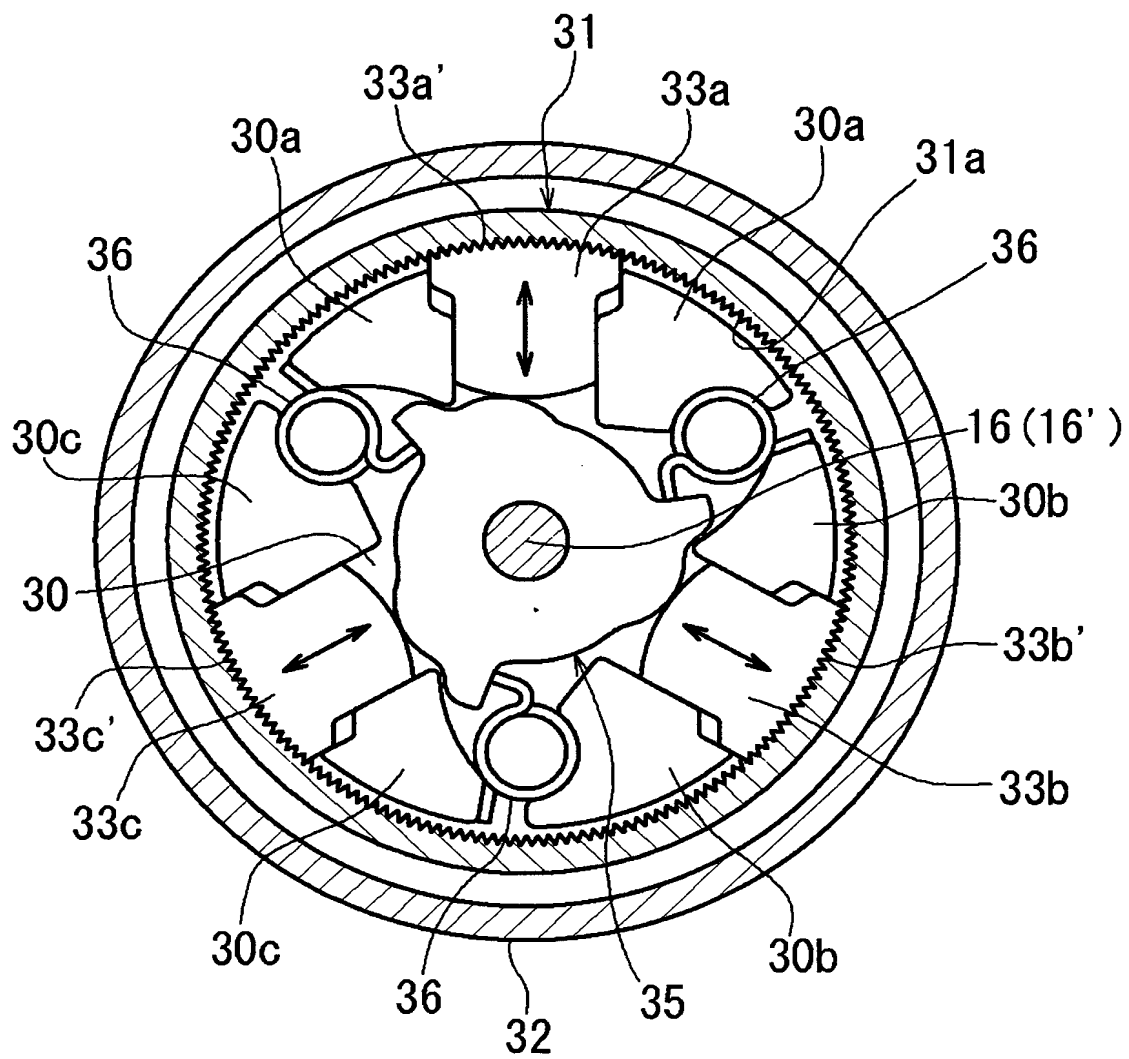


Fig.16

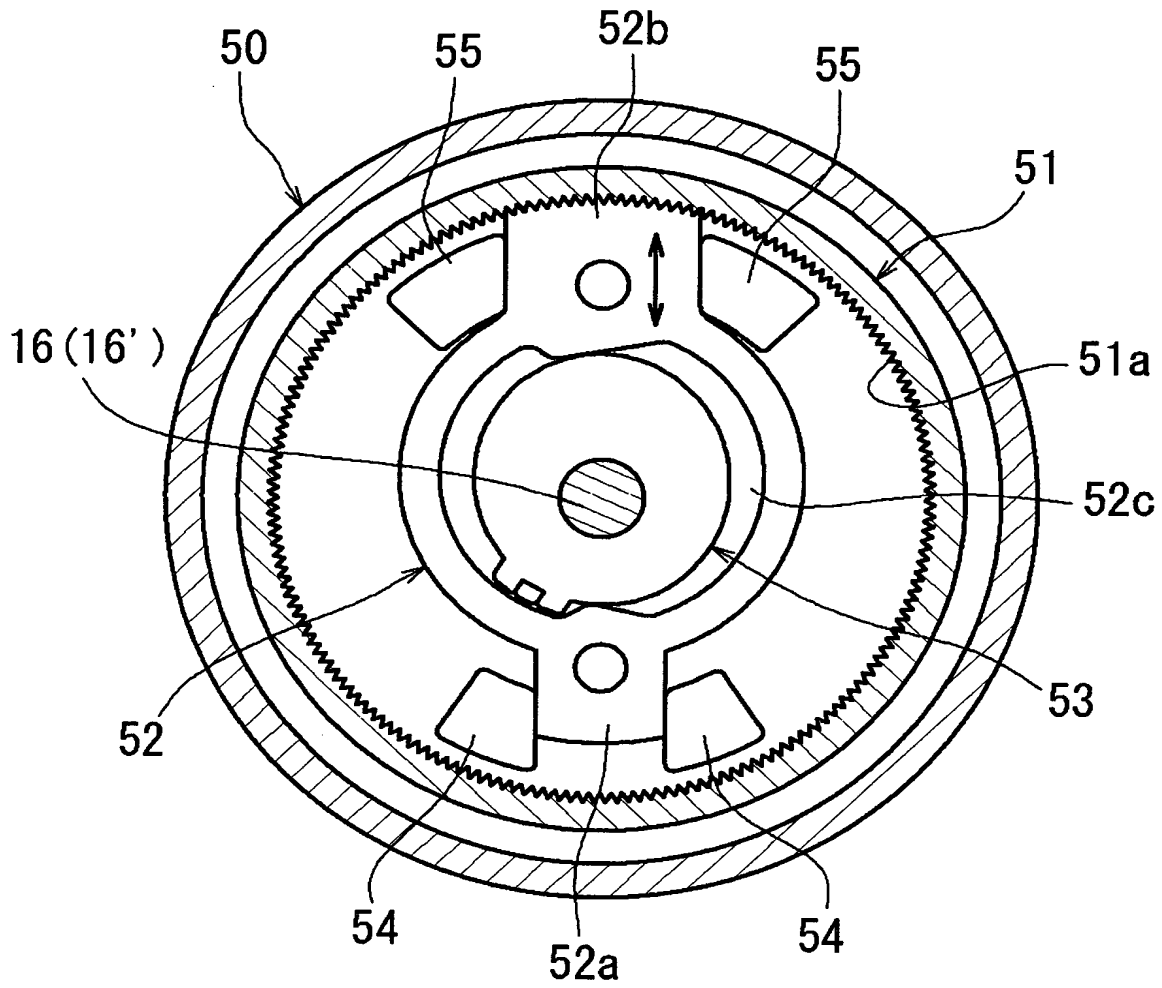


Fig 17

